



Intelligent Antennas

Guest Editor:

Prof. Pedram Mousavi

Department of Mechanical
Engineering, University of
Alberta, Edmonton, AB T6G 1H9,
Canada

Deadline for manuscript
submissions:

closed (31 May 2019)

Message from the Guest Editor

The unprecedented emergence of new wireless applications in recent years pervades all aspect of our lives. To handle the demand, the telecommunication industry will develop the 5th generation of networks. These devices will be used in many applications such as telecommunication networks, health care, sensing, imaging, oil and gas, military, transportation, wearable devices, smart appliances and smart buildings. Hosting all these applications and accommodating future applications in a single platform will require reconfigurable, flexible, multi-band, energy smart (such as harvesting) and intelligent antennas. This Special Issue will present scholarly papers that address critical issues in theory, design, manufacturing (use of new materials and manufacturing process such as 3D printing) and measurements (such as fast near-field measurements) of intelligent antennas.

More information, please click [here](#).





an Open Access Journal by MDPI

Editor-in-Chief

Prof. Dr. Flavio Canavero

Department of Electronics and
Telecommunications,
Politecnico di Torino, 10129
Torino, Italy

Message from the Editor-in-Chief

Electronics is a multidisciplinary journal designed to appeal to a diverse audience of research scientists, practitioners, and developers in academia and industry. The journal is devoted to fast publication of latest technological breakthroughs, cutting-edge developments, and timely reviews of current and emerging technologies related to the broad field of electronics. Experimental and theoretical results are published as regular peer-reviewed articles or as articles within Special Issues guest-edited by leading experts in selected topics of interest.

Author Benefits

Open Access: free for readers, with article processing charges (APC) paid by authors or their institutions.

High Visibility: indexed within Scopus, SCIE (Web of Science), CAPlus / SciFinder, Inspec, and other databases.

Journal Rank: JCR - Q2 (*Electrical and Electronic Engineering*) CiteScore - Q2 (*Electrical and Electronic Engineering*)

Contact Us

Electronics Editorial Office
MDPI, St. Alban-Anlage 66
4052 Basel, Switzerland

Tel: +41 61 683 77 34
www.mdpi.com

mdpi.com/journal/electronics
electronics@mdpi.com
[X@electronicsMDPI](https://twitter.com/electronicsMDPI)